

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
1mm CONTACT SPACING FPC CONNECTOR (HFW _ _ R-1/2ST _ _ HLF)		PAGE 1 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

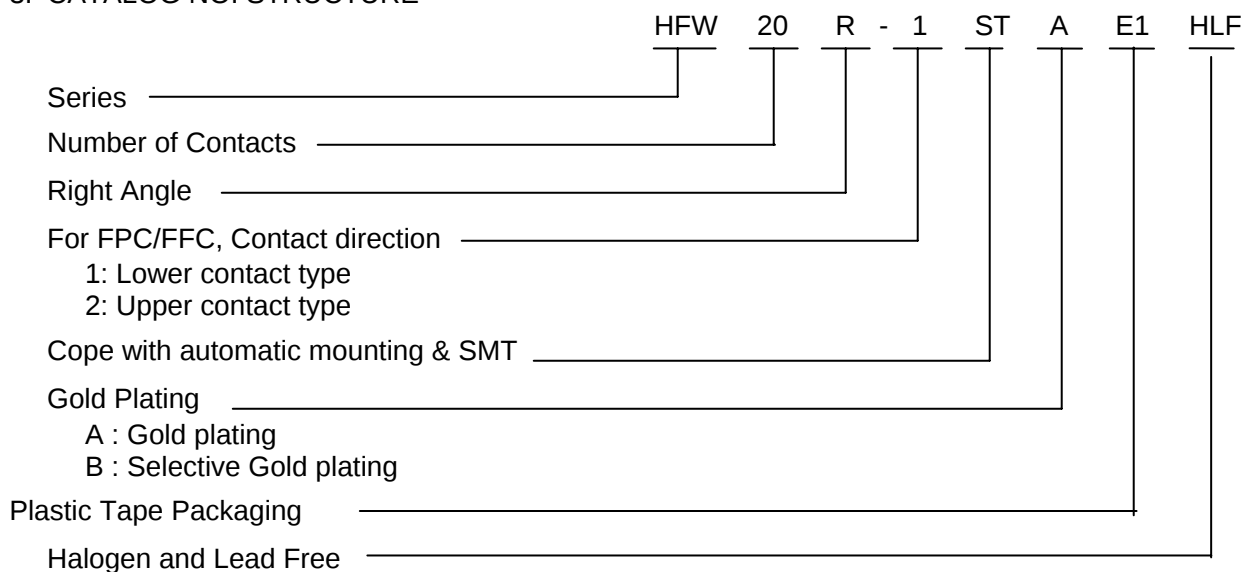
1. SCOPE

This specification covers the requirements for the connector (HFW _ _ R-1/2STA _ _ HLF) which the edge of 1mm spacing FPC(Flexible Printed Circuit) and FFC(Flexible Flat Cable) are inserted into directly and connected to and which copes with automatic mounting and SMT.

2. APPLICABLE STANDARDS

JIS C 5402 Method for Test of Connectors for Electronic Equipment
 JIS C 0806 Packaging of Electronic Components on Continuous Tapes
 (Surface Mount Components)
 UL - 94 TESTS FOR FLAMMABILITY OF PLASTIC MATERIALS FOR PARTS
 IN DEVICES AND APPLIANCES

3. CATALOG NO. STRUCTURE



4. CONNECTOR SHAPE, DIMENSIONS AND MARTERIALS

Refer product drawings.

5. ACCOMMODATED CONDUCTORS (FPC)

Refer product drawings.

6. PACKAGING CONDITION

Refer product drawings.

7. RECOMMENDED MOUNTING PATTERN DIMENSIONS

Refer product drawings.

8. RATING

8-1. Voltage: A.C. 100V D.C. 100V

8-2. Current : A.C. 1A D.C. 1A (Refer to the following note.)

8-3. Operating Temperature : -55°C ~ +105°C (Including terminal temperature rises)

PDS: Rev :C

STATUS:Released

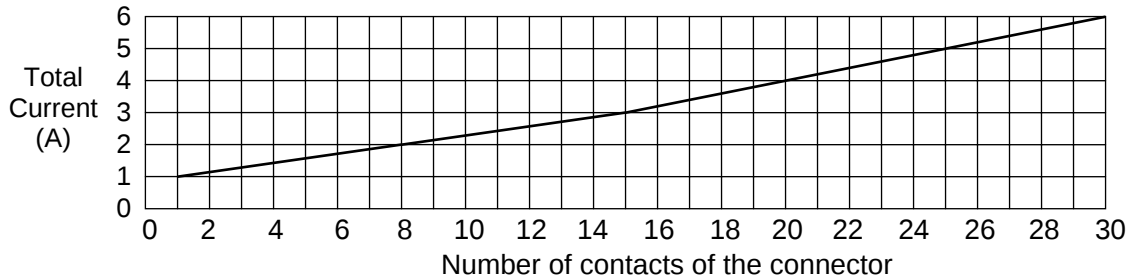
Printed: May 30, 2012

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
TITLE 1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 2 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 3 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

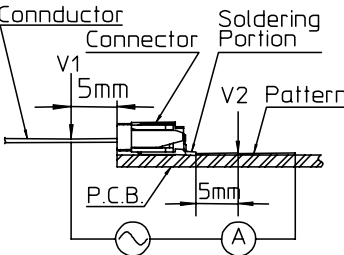
NOTE

Allowable maximum current for one contact is 1A. Total allowable current for a whole connector is the value which is shown in the following figure.



9. PERFORMANCE CHARACTERISTICS

9-1. Electrical Performance

No.	Test Item	Test Method	Requirements
9-1-1	Contact resistance	1) Measure contact resistance between V_1 - V_2 by voltage drop method using the following circuit by mating accommodated conductor specified in clause 5 after reflow soldering the connector on the P.C.B.  2) Open circuit voltage : Less than A.C. 20mV 3) Test current : Less than A.C. 20mA	1) Initial value: Less than 30mΩ 2) Contact resistance after the test is in accordance with the value specified in each test item.
9-1-2	Insulation resistance	1) Measure insulation resistance between adjacent contacts in a connector individual. 2) Test voltage : D.C. 500V 3) Read value one minute after applying test voltage.	1) More than 500MΩ
9-1-3	Dielectric withstanding voltage	1) For one minute, apply A.C. 500V between adjacent contacts in a connector individual. 2) Set current : A.C. 1mA	1) Free from any short circuit and insulation breakdown.

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
TITLE 1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 4 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

9-2. Mechanical Performance

No.	Test Item	Test Method	Requirements
9-2-1	Durability (Insertion and extraction)	1) Measure contact resistance before and after the test by the method in clause 9-1-1 by using the accommodated conductor specified in clause 5. 2) Number of insertion and extraction: 30 times. 3) Speed of insertion and extraction: Less than 10 times per minute.	1) Initial contact resistance: Less than 30mΩ 2) Contact resistance after the test: Less than 50mΩ 3) Free from any defect such as break etc. on the connector and the conductor.
9-2-2	Vibration (Sinusoidal)	JIS C 60068-2-6 (IEC60068-2-6) 1) Frequency range : 10 ~ 500Hz 2) Amplitude : 0.75mm or Acceleration : 100m/s ² 3) Sweep rate : 1 octave / minute 4) Kind of test : Sweep endurance test 5) Test time : 10 cycles	1) During the test, no circuit opening for more than 1μs 2) Free from any defect such as break, deformation, loosening and falling off etc. on each portion of the connector.

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
TITLE 1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 5 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

9-3. Environmental Performance

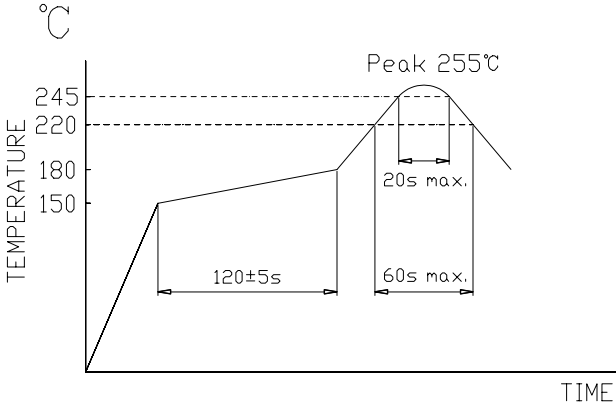
No.	Test Item	Test Method	Requirements
9-3-1	Damp heat (Steady state)	JIS C 60068-2-78 (IEC60068-2-78) 1) Measure contact resistance before and after the test by the method in clause 9-1-1 by using the accommodated conductor specified in clause 5. 2) Measure insulation resistance after the test by the method in clause 9-1-2. 3) Bath temperature : 40°C 4) Bath humidity : 90~95% (Relative humidity) 5) Period of exposure : 48 hours 6) Expose conductor and connector after mating them (Without insertion and extraction) and dry them naturally after posttreatment.	1) Initial contact resistance: Less than 30mΩ 2) Contact resistance after the test: Less than 50mΩ 3) Insulation resistance after the test: More than 100MΩ
9-3-2	Salt spray	JIS C 60068-2-11 (IEC60068-2-11) 1) Measure contact resistance before and after the test according to the method in clause 9-1-1 by using accommodated conductor specified in clause 5. 2) Salt solution concentration : 5% 3) Period of exposure : 48 hours 4) Expose conductor and connector in mated condition and dry them naturally after post treatment. (24 hours)	1) Initial contact resistance Less than 30mΩ 2) Contact resistance after the test: Less than 50mΩ

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
TITLE 1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 6 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

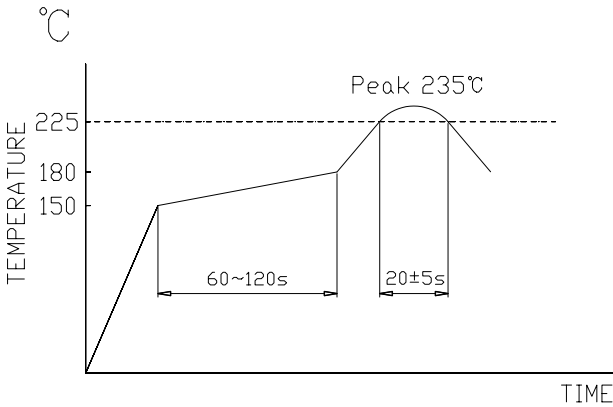
No.	Test Item	Test Method	Requirements															
9-3-3	Change of temperature	JIS C 0025 (IEC60068-2-14)																
		1) Measure contact resistance before and after the test according to the method in clause 9-1-1 by mating accommodated conductor in clause 5.	1) Initial contact resistance: Less than 30mΩ															
		2) One cycle of temperature is as follow and test 5 cycles.	2) Contact resistance after the test: Less than 50mΩ															
		<table><tr><th>Step</th><th>Temp.(°C)</th><th>Time (min.)</th></tr><tr><td>1</td><td>-55±3</td><td>30</td></tr><tr><td>2</td><td>25±2</td><td>2 ~ 3</td></tr><tr><td>3</td><td>105±2</td><td>30</td></tr><tr><td>4</td><td>25±2</td><td>2 ~ 3</td></tr></table>	Step	Temp.(°C)	Time (min.)	1	-55±3	30	2	25±2	2 ~ 3	3	105±2	30	4	25±2	2 ~ 3	3) Free from any defect such as crack, warping and deformation etc. on each portion of the connector.
Step	Temp.(°C)	Time (min.)																
1	-55±3	30																
2	25±2	2 ~ 3																
3	105±2	30																
4	25±2	2 ~ 3																
		3) Expose conductor and connector by mating them and leave them under normal temperature.																

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 7 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

9-4. Other performance

No.	Test Item	Test Method	Requirements
9-4-1	Soldering (Resistance to reflow soldering)	JIS C 60068-2-58 (IEC60068-2-58) 1) Solder by setting reflow bath on the following condition. 2) Preheating : 150~180°C, 120±5s 3) Soldering : 220°C min. 60s max. 4) Peak : 245°C min. 20s max. (Peak 255°C max.) (See Diagram A) Note: Temperature must be measured at contact terminal portion and peak temperature on the upper surface of P.C.B must be less than 260°C. 5) Solder paste to be used is JIS Z 3282 Sn96.5Ag3.0Cu0.5	1) Contact resistance after the test Less than 50mΩ 2) Insulation resistance after The test: More than 100MΩ 3) No short circuit and insulation Breakdown for dielectric withstanding voltage test after this test. 4) Free from any damage on performance and contact performance after soldering.
<u>Diagram A</u>  Resistance to reflow soldering profile			

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 8 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

No.	Test Item	Test Method	Requirements
9-4-2	Soldering (Solderability) (Reflow)	JIS C 60068-2-58 (IEC60068-2-58) 1) Solder by setting reflow bath on the following condition. 2) Preheating : 150~180°C, 60~120s 3) Soldering : 225°C min., 20±5s (Peak 235°C max.) (See Diagram B) Note : Temperature must be measured at contact terminal portion and peak temperature on the upper surface of P.C.B must be less than 260°C. 4) Solder paste to be used is JIS Z 3282 Sn96.5Ag3.0Cu0.5	1) Actual soldered area must be more than 95% of the dipped area intended to be soldered.
		<u>Diagram B</u>  Solderability profile	
9-4-3	Cable insertion force and retention force (Reference)	1) Measure insertion force and retention force by using the accommodated conductor (cable)	Initial Insertion: Less than 1.7N/contact Retention: More than 0.34N/contact

NUMBER GS-12-598	TYPE PRODUCT SPECIFICATION		
1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 9 of 10	REVISION C
		AUTHORIZED BY S.Watanabe	DATE 28 MAY 2012
		CLASSIFICATION UNRESTRICTED	

10. INDICATION AND PACKAGING

10-1. Indication

- 1) Catalog number and lot number are not indicated on the connector.
- 2) Catalog number and quantity shall be indicated on the surface of the package box.

10-2. Packaging

- 1) The connector individuals are packed by tapes with specified quantity in accordance with [JIS C 0806 "Packaging of Electronic Components on Continuous Tapes (Surface Mount components)"] and put into package box in accordance with our packaging specification.

11. REMARKS

11-1. Please use for Gold plating FPC as accommodated conductor.

11-2. Insertion and extraction force for accommodated conductor (cable) specified in clause 9-4-3 differs due to it's kind, structure and surface treatment of conductor. Therefore, the force value specified in the clause for performance is reference value.

11-3 Please refer to the "Handling procedures and remarks" before use.

12. RECOMMENDED REFLOW PROFILE

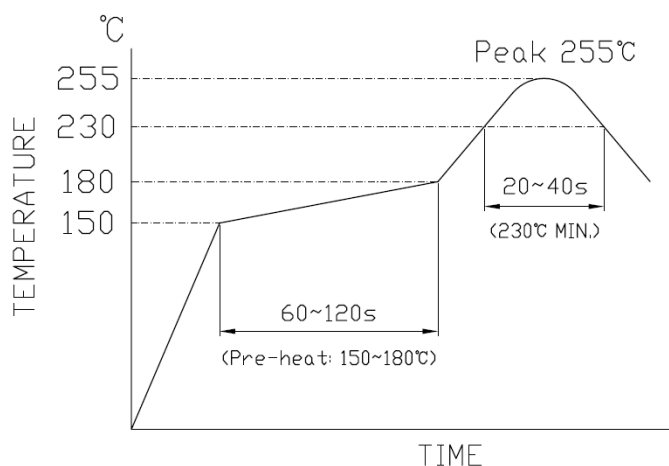


Diagram C. Recommended reflow temperature profile

Note: Please check the reflow soldering condition for your own application beforehand due to different conditions with soldering devices, P.C. Boards, etc.
No moisture treatment before reflow process.

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TITLE 1mm CONTACT SPACING FPC CONNECTOR (HFW_ _R-1/2ST_ _ _HLF)		PAGE 10 of 10	REVISION C
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13. REVISION RECORD

REV.	PAGE	DESCRIPTION	ECR #	DATE
A	All	New Release	S09-0108	06 Apr 09
B	ALL	Corrected writing error (Cable retention force) Revise spec for lead-free solder Add "Diagram A" Resistance to Reflow Soldering Profile. Add "Diagram B" Solderability Profile. Add "Diagram C" Recommended Reflow Profile.	J10-0039	18 Feb 10
C	1	Add New P/N for Selective Gold plating		28 May 12

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